



## 20V N-Channel Trench Power MOSFET

### General Description

The SJK20ND170 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

### Features

- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	20	V
$R_{DS(ON\_TYP)}$	17.8	m $\Omega$
$I_D$	7.9	A
$Q_G$	19	nC



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJK20ND170	SJK20ND170	TSSOP-8	Tape	\	\	3000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	40	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^{\circ}\text{C}$ )	7.9	A
	Drain Current-Continuous( $T_A=100^{\circ}\text{C}$ )	5	A
$I_{DM}(\text{pluse})$	Drain Current-Continuous@ Current-Pulsed (Note 1)	31.6	A
$P_D$	Maximum Power Dissipation( $T_A=25^{\circ}\text{C}$ )	2	W
	Maximum Power Dissipation( $T_A=100^{\circ}\text{C}$ )	0.8	W
$E_{AS}$	Avalanche energy (Note 2)	25	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\text{C}$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to- Ambient		62	$^{\circ}\text{C}/\text{W}$



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃			1	μA
		V <sub>DS</sub> =20V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1		2.5	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =2A		69		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A T <sub>J</sub> =25℃		17.8	23.1	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =2.5V, I <sub>D</sub> =2A T <sub>J</sub> =25℃		20.8	27.7	mΩ
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =4.5V, V <sub>GS</sub> =0V, f=1.0MHz		785		pF
C <sub>oss</sub>	Output Capacitance			129		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			108		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		3.4		Ω
Switching Parameters						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, R <sub>L</sub> =3Ω, R <sub>GEN</sub> =3Ω		6.4		nS
t <sub>r</sub>	Turn-on Rise Time			2.4		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			30.8		nS
t <sub>f</sub>	Turn-Off Fall Time			3		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =21V, I <sub>D</sub> =3A		19		nC
Q <sub>gs</sub>	Gate-Source Charge			1.5		nC
Q <sub>gd</sub>	Gate-Drain Charge			2.7		nC
Source-Drain Diode Characteristics						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				7.9	A
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =3A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =3A, dI/dt=100A/μs		14		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =3A, dI/dt=100A/μs		5.2		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

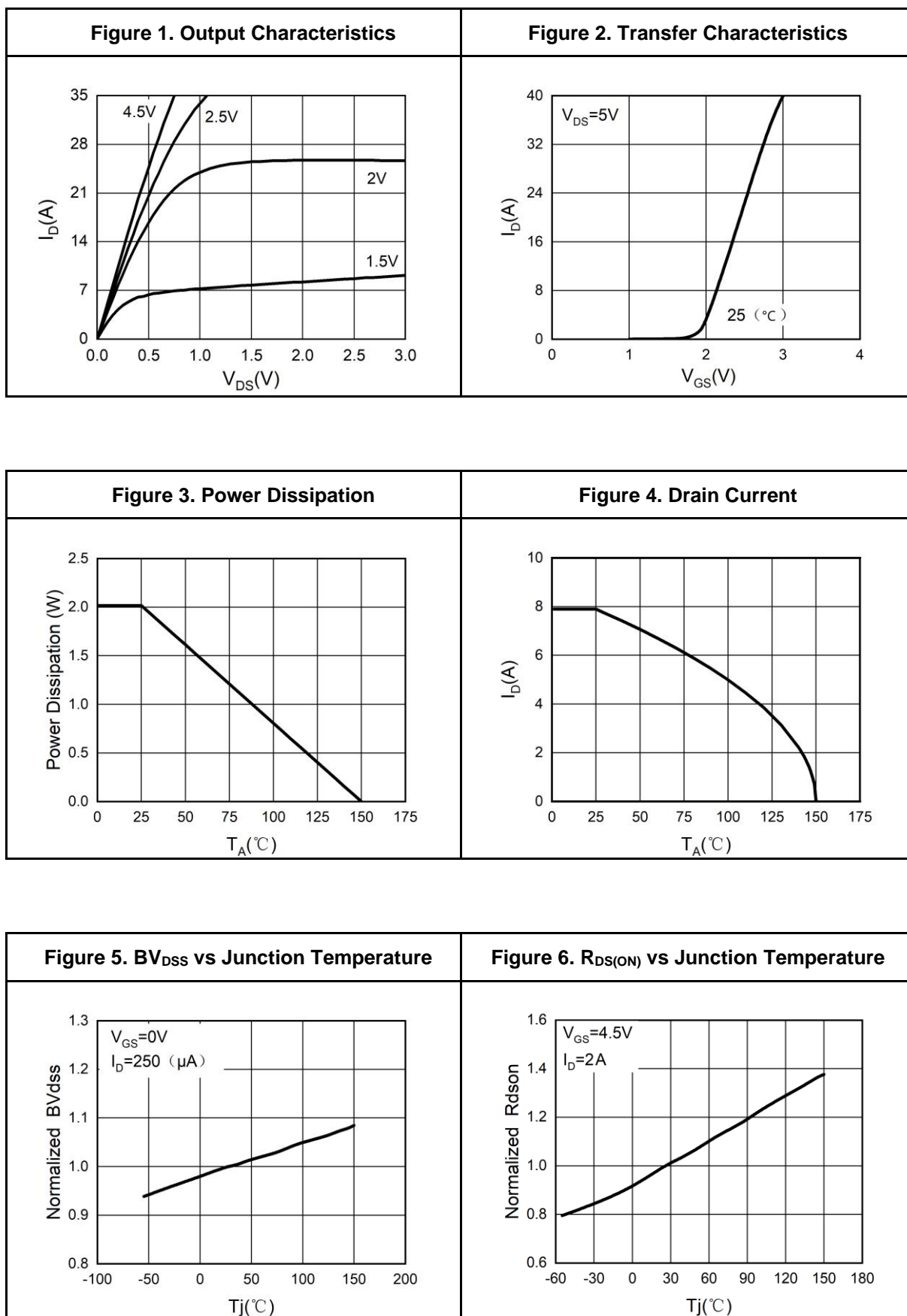
Notes 2.EAS condition:  $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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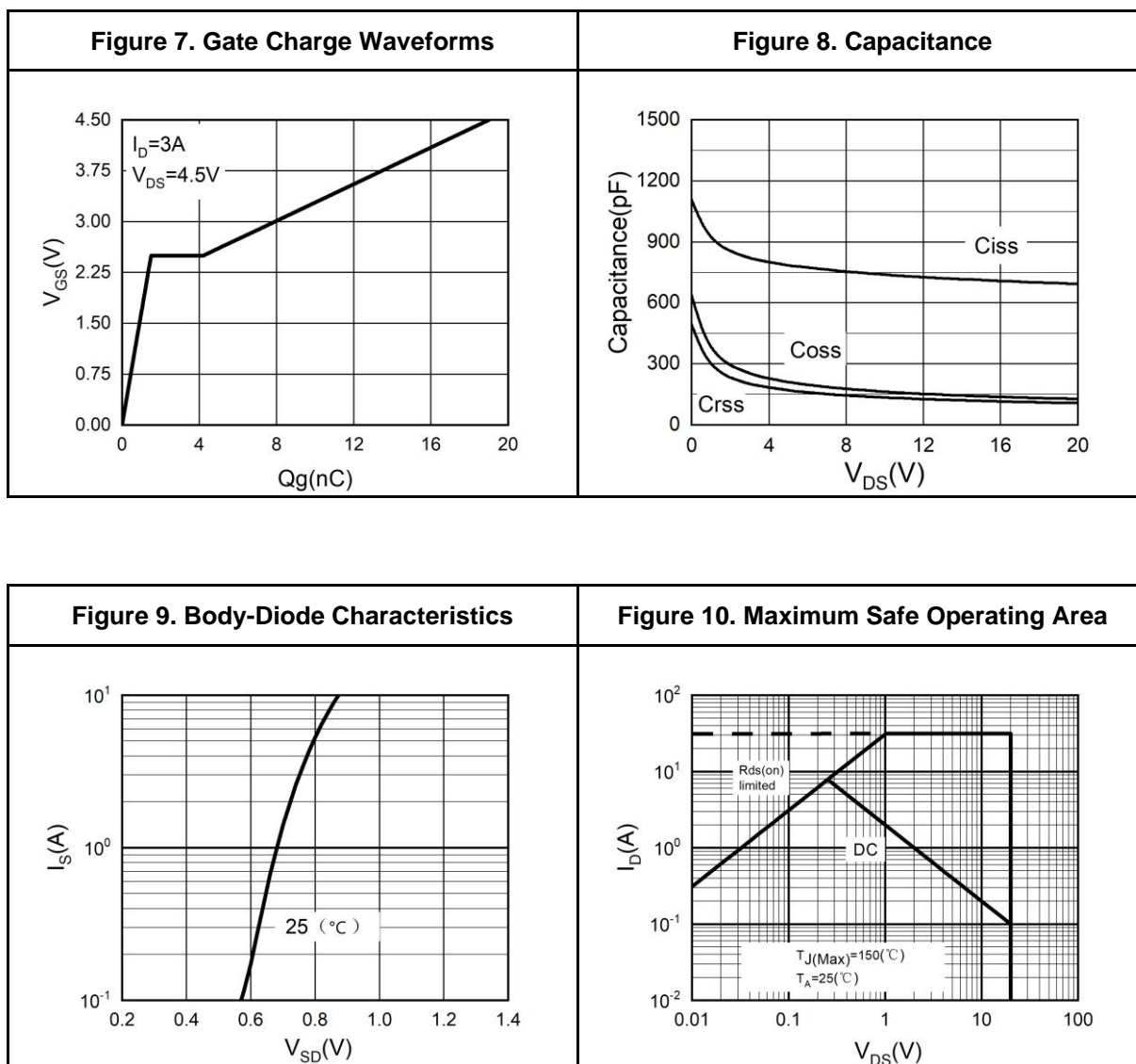
### Typical Electrical And Thermal Characteristics (Curves)





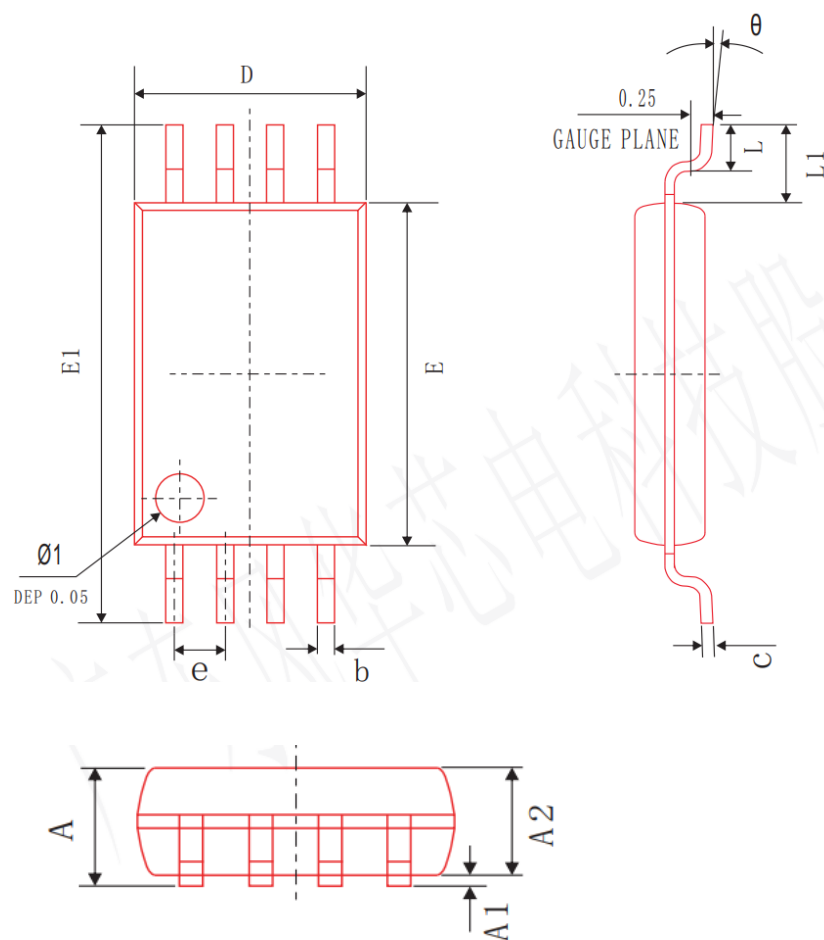
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### Typical Electrical And Thermal Characteristics (Curves)





## TSSOP-8 Package Information



COMMON DIMENSIONS  
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	1.00	1.10	1.20
A1	0.02	0.10	0.18
A2	0.90	1.00	1.10
b	0.17	0.22	0.27
c	0.122	0.127	0.132
L	0.40	0.60	0.80
D	2.87	2.97	3.07
E	4.30	4.40	4.50
E1	6.20	6.40	6.60
Ø1	0.50	0.60	0.70
θ	0°	5°	10°
L1	1.00 BSC		
e	0.65 BSC		



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